

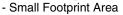
Vishay Siliconix

# **Dual P-Channel 20-V (D-S) MOSFET**

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	$R_{DS(on)}(\Omega)$	I <sub>D</sub> (A)	Q <sub>g</sub> (Typ.)	
- 20	$0.110 \text{ at V}_{GS} = -4.5 \text{ V}$	- 4.5 <sup>a</sup>	3 nC	
- 20	$0.185$ at $V_{GS} = -2.5 \text{ V}$	- 4.5 <sup>a</sup>	3110	

#### **FEATURES**

- · Halogen-free
- TrenchFET® Power MOSFET
- New Thermally Enhanced PowerPAK® SC-70 Package



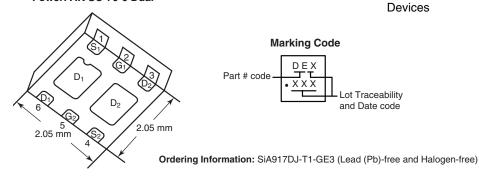
- Low On-Resistance

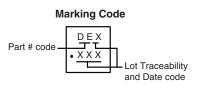
**APPLICATIONS** 

**Devices** 



#### PowerPAK SC-70-6 Dual





Load Switch, PA Switch and Battery Switch for Portable

P-Channel MOSFET P-Channel MOSFET

Parameter		Symbol	Limit	Unit
Drain-Source Voltage	$V_{DS}$	- 20	V	
Gate-Source Voltage		V <sub>GS</sub>	V <sub>GS</sub> ± 12	
	T <sub>C</sub> = 25 °C		- 4.5 <sup>a</sup>	
Continuous Drain Current (T <sub>.1</sub> = 150 °C)	T <sub>C</sub> = 70 °C	I <sub>D</sub>	- 4.5 <sup>a</sup>	
Continuous Diain Current (1) = 130 C)	T <sub>A</sub> = 25 °C	'D	- 3.3 <sup>b, c</sup>	
	T <sub>A</sub> = 70 °C		- 2.4 <sup>b, c</sup>	A
Pulsed Drain Current		I <sub>DM</sub> - 10		
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C	I <sub>S</sub>	- 4.5 <sup>a</sup>	
Continuous Source-Drain Diode Guirent	T <sub>A</sub> = 25 °C	'S	- 1.6 <sup>b, c</sup>	
	T <sub>C</sub> = 25 °C		6.5	
Maximum Power Dissipation	T <sub>C</sub> = 70 °C	P <sub>D</sub>	5	_ w
	T <sub>A</sub> = 25 °C	' b	1.9 <sup>b, c</sup>	
	T <sub>A</sub> = 70 °C		1.2 <sup>b, c</sup>	
Operating Junction and Storage Temperature R	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C	
Soldering Recommendations (Peak Temperature) <sup>d, e</sup>			260	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient (MOSFET) <sup>b, f</sup>	t ≤ 5 s	R <sub>thJA</sub>	52	65	°C/W	
Maximum Junction-to-Case (Drain) (MOSFET)	Steady State	$R_{thJC}$	12.5	16	0/11	

#### Notes:

- a. Package limited.
- b. Surface Mounted on 1" x 1" FR4 board.
- d. See Solder Profile (http://www.vishay.com/ppg?73257). The PowerPAK SC-70 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- e. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.
- f. Maximum under Steady State conditions is 110 °C/W.

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<b>SPECIFICATIONS</b> T <sub>J</sub> = 25 °C, unless otherwise noted							
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	$V_{DS}$	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	- 20			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = - 250 μA		- 16		mV/°C	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	1 <sub>D</sub> = - 230 μΑ		2.5			
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 0.6		- 1.5	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 12 \text{ V}$			± 100	nA	
Zero Gate Voltage Drain Current	laco	V <sub>DS</sub> = - 20 V, V <sub>GS</sub> = 0 V			- 1	μА	
	I <sub>DSS</sub>	$V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$			- 10		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \le$ - 5 V, $V_{GS} =$ - 4.5 V	5			Α	
Drain-Source On-State Resistance <sup>a</sup>	B	$V_{GS} = -4.5 \text{ V}, I_D = -2.5 \text{ A}$		0.091	0.110	Ω	
	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 2.5 V, I <sub>D</sub> = - 0.54 A		0.152	0.185		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	$V_{DS} = -10 \text{ V}, I_{D} = -2.5 \text{ A}$		3.5		S	
Dynamic <sup>b</sup>							
Input Capacitance	C <sub>iss</sub>			250		pF	
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = - 10 V, V <sub>GS</sub> = 0 V, f = 1 MHz		70			
Reverse Transfer Capacitance	C <sub>rss</sub>			45			
Total Cata Charge	Qg	V <sub>DS</sub> = - 10 V, V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 3.3 A		6	9	nC	
Total Gate Charge				3	4.5		
Gate-Source Charge	$Q_{gs}$	$V_{DS} = -10 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -3.3 \text{ A}$		0.7			
Gate-Drain Charge	$Q_{gd}$			0.9			
Gate Resistance	$R_g$	f = 1 MHz		8		Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			20	30	ns	
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 10 V, $R_L$ = 3.9 $\Omega$		45	70		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong$ - 2.6 A, $V_{GEN}$ = - 4.5 V, $R_g$ = 1 $\Omega$		15	25		
Fall Time	t <sub>f</sub>			10	15		
Turn-On Delay Time	t <sub>d(on)</sub>			4	8		
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 10 V, $R_L$ = 3.9 $\Omega$		12	20		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong$ - 2.6 A, $V_{GEN}$ = - 10 V, $R_g$ = 1 $\Omega$		12	20		
Fall Time	t <sub>f</sub>			5	10		
<b>Drain-Source Body Diode Characterist</b>	ics						
Continuous Source-Drain Diode Current	I <sub>S</sub>	T <sub>C</sub> = 25 °C			- 4.5	А	
Pulse Diode Forward Current	I <sub>SM</sub>				- 10		
Body Diode Voltage	$V_{SD}$	$I_S = -2.6 \text{ A}, V_{GS} = 0 \text{ V}$		- 0.8	- 1.2	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			20	40	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	I <sub>F</sub> = - 2.6 A, di/dt = 100 A/μs, T <sub>J</sub> = 25 °C		10	20	nC	
Reverse Recovery Fall Time	t <sub>a</sub>	$-1_{\text{F}} = -2.0 \text{ A}, \text{ u/ut} = 100 \text{ A/}\mu\text{s}, 1_{\text{J}} = 25 \text{ °C}$		8		- ns	
Reverse Recovery Rise Time	t <sub>b</sub>			12			

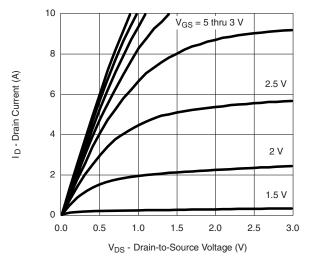
- a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

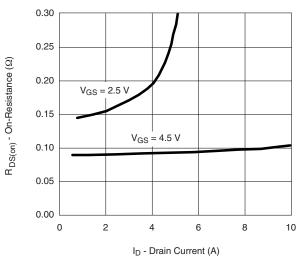


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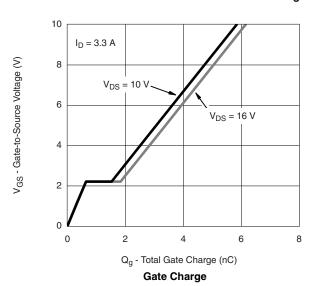
## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



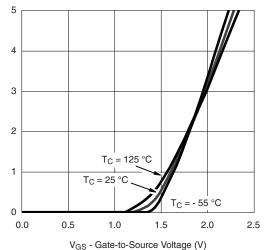
#### **Output Characteristics**



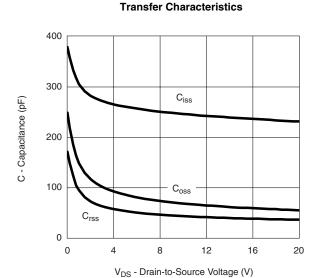
#### On-Resistance vs. Drain Current and Gate Voltage



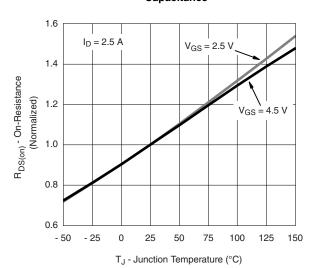
I<sub>D</sub> - Drain Current (A)



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Capacitance

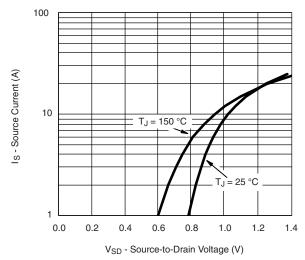


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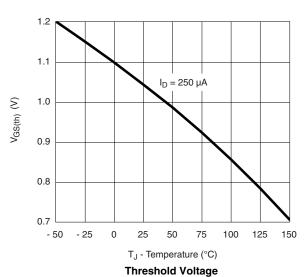
# Vishay Siliconix

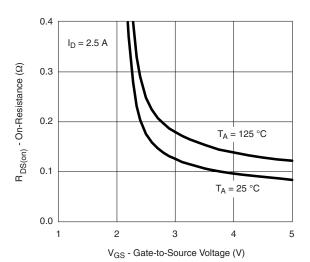
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# TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

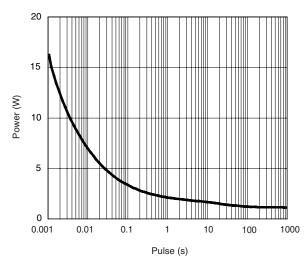


### Soure-Drain Diode Forward Voltage

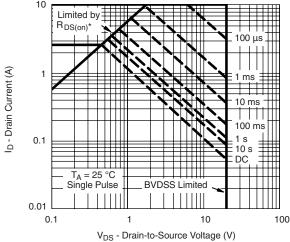




On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



\*  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

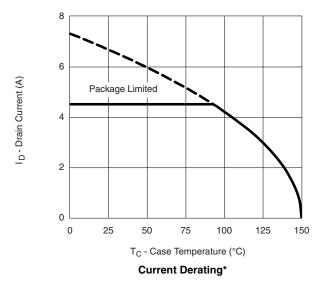
Safe Operating Area, Junction-to-Ambient

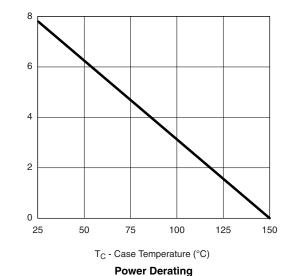
Power Dissipation (W)



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# TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





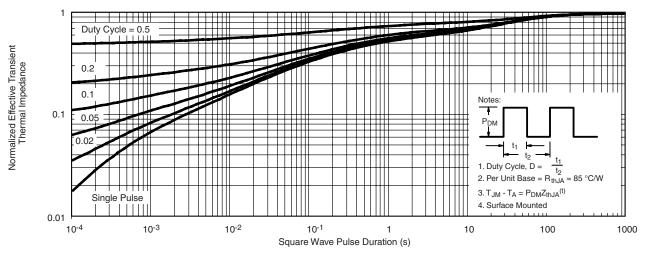
<sup>\*</sup> The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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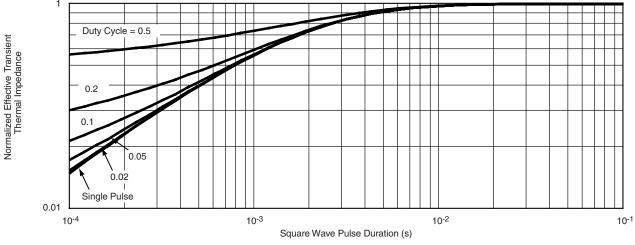
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## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



#### Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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